
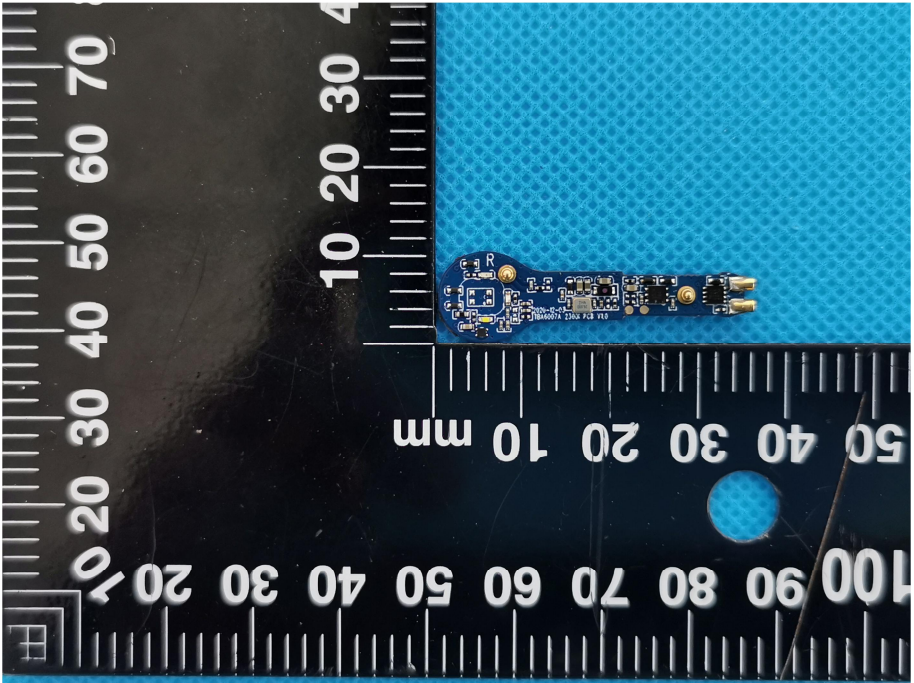
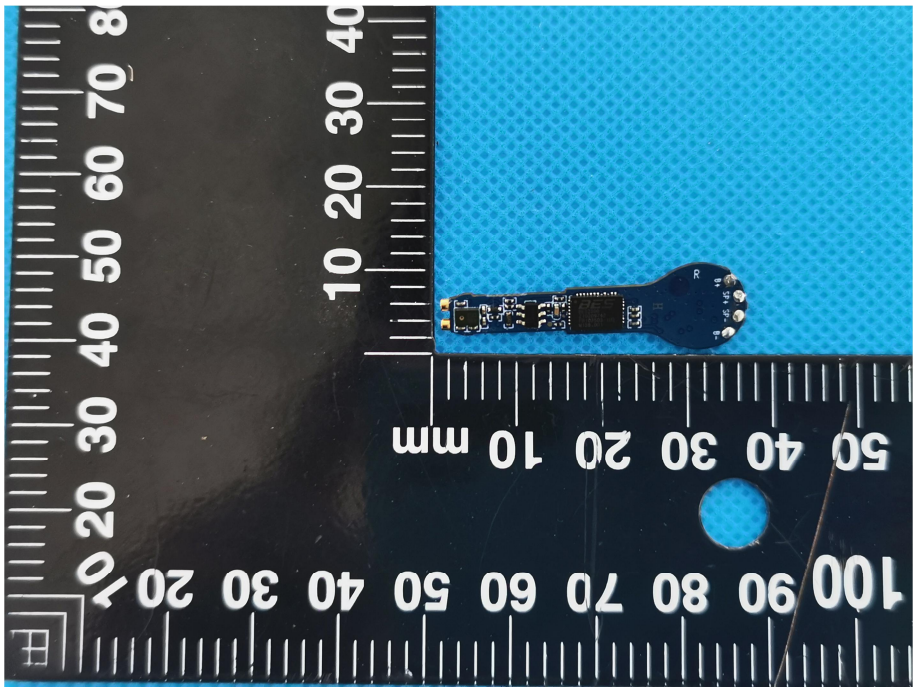
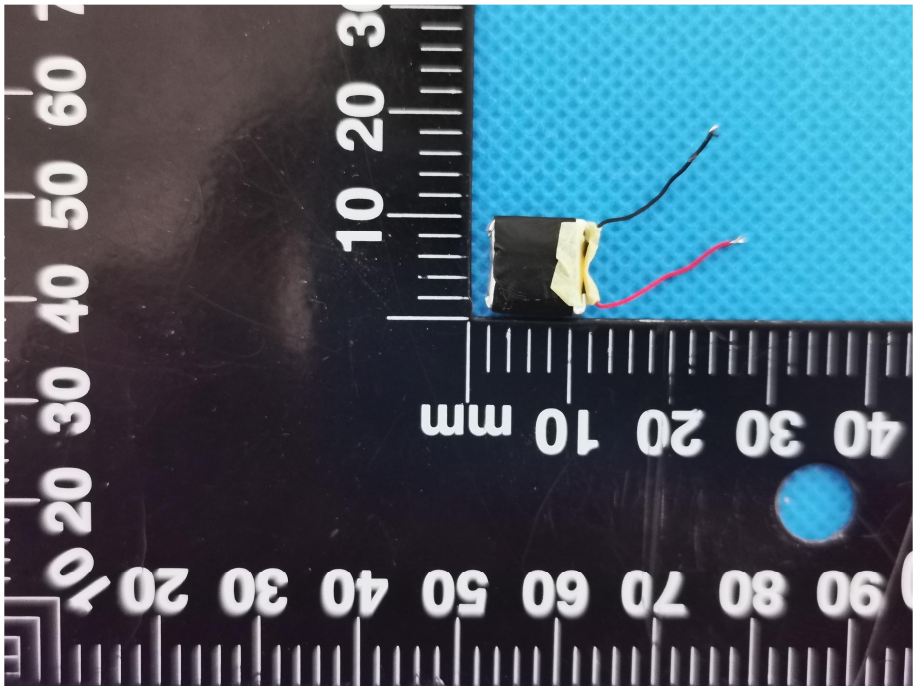
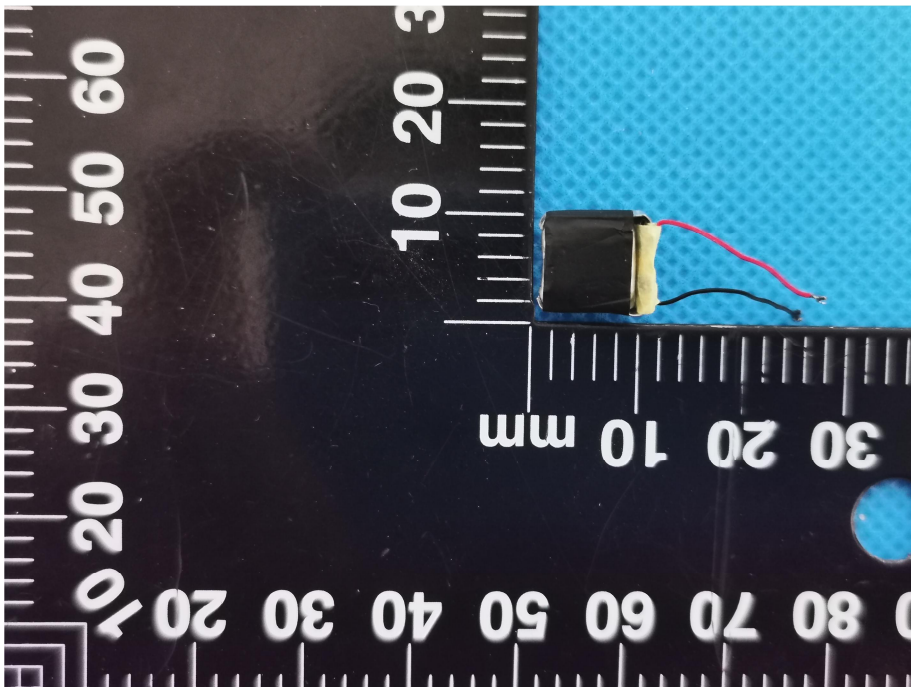
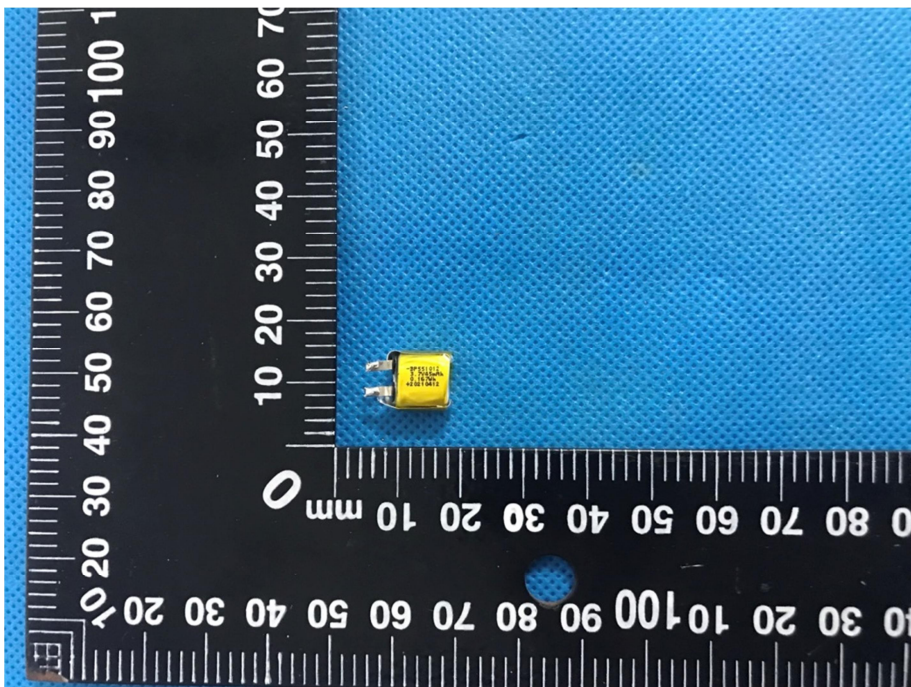


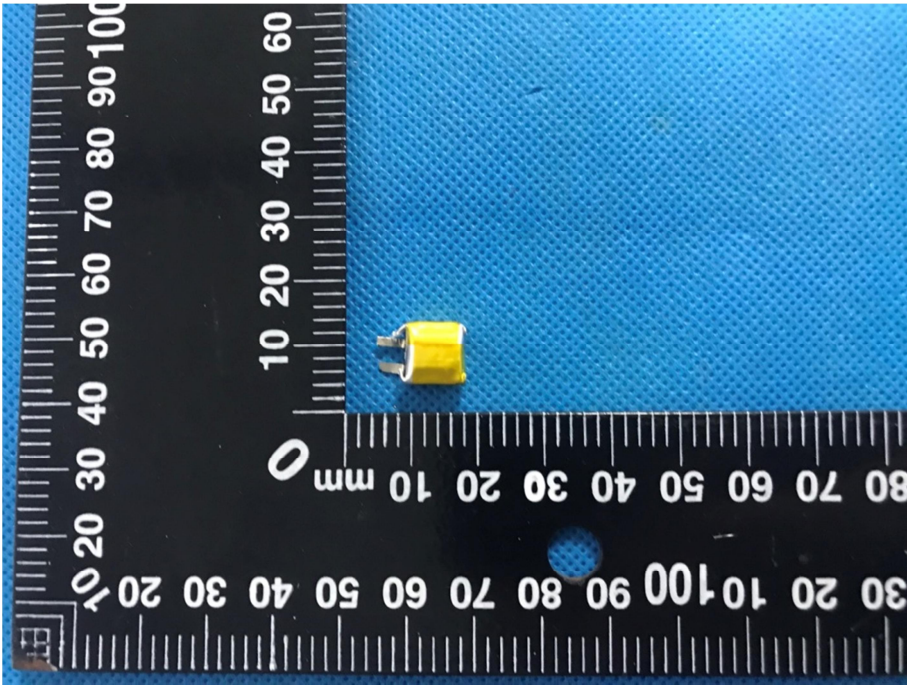
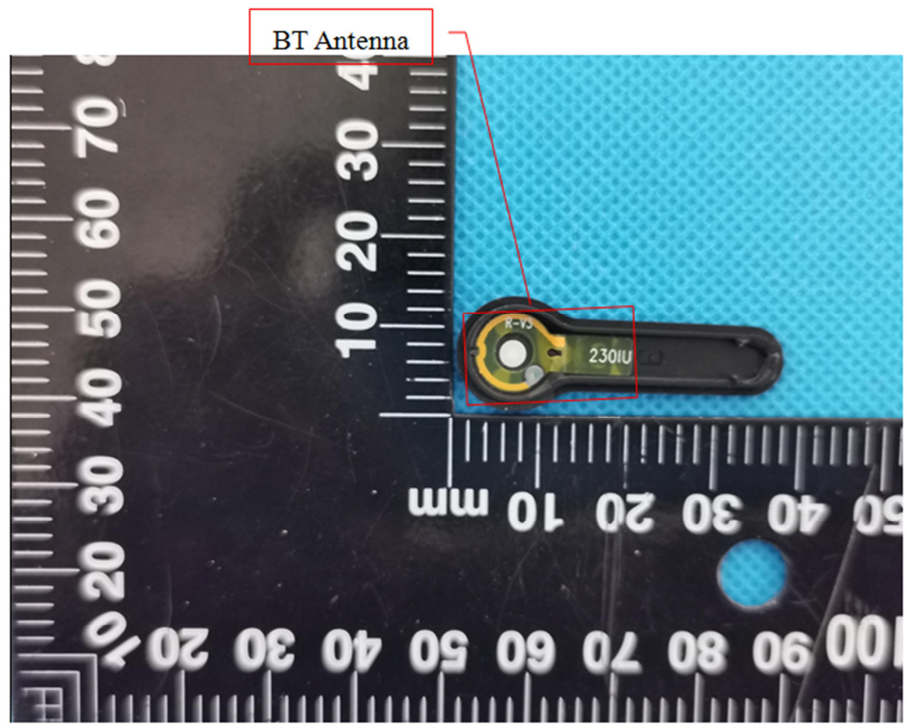
EXHIBIT 3 - EUT INTERNAL PHOTOGRAPHS

Right headset


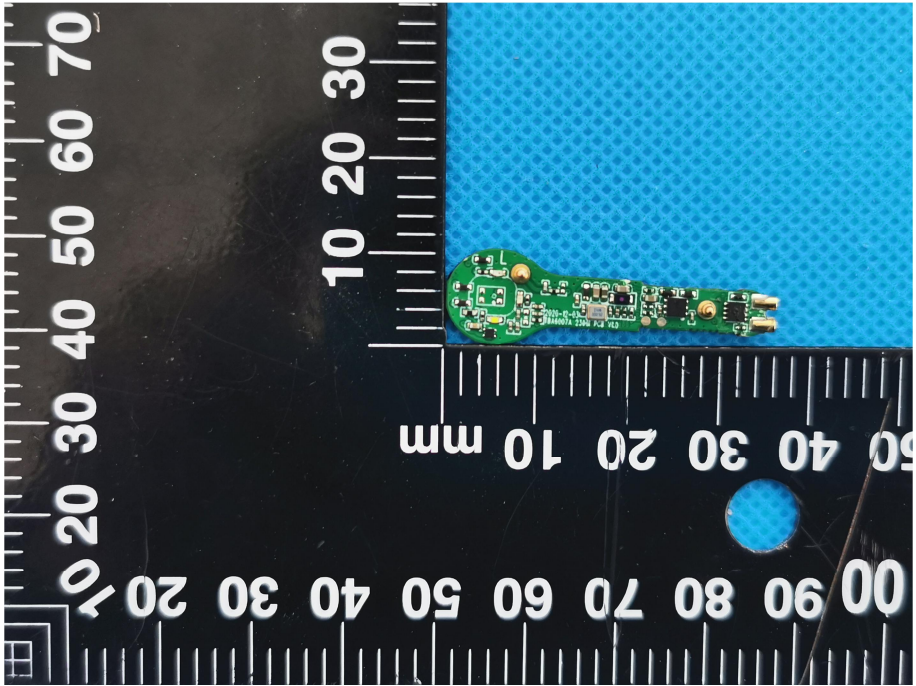
<p>EUT Housing and Board View 1</p>	 A photograph showing the disassembled components of a right headset. The components, including a black plastic housing, a small circular lens, and a blue printed circuit board (PCB) with various electronic components, are laid out on a blue textured surface. A black ruler with white markings is placed vertically and horizontally to provide scale. The ruler markings are in millimeters, with the vertical scale on the left and the horizontal scale at the bottom.
<p>Solder Board-Component View 1</p>	 A close-up photograph of a small blue PCB component, likely a microphone or sensor, which has been soldered onto a larger board. The component is positioned on a blue textured surface. A black ruler with white markings is placed vertically and horizontally to provide scale. The ruler markings are in millimeters, with the vertical scale on the left and the horizontal scale at the bottom.

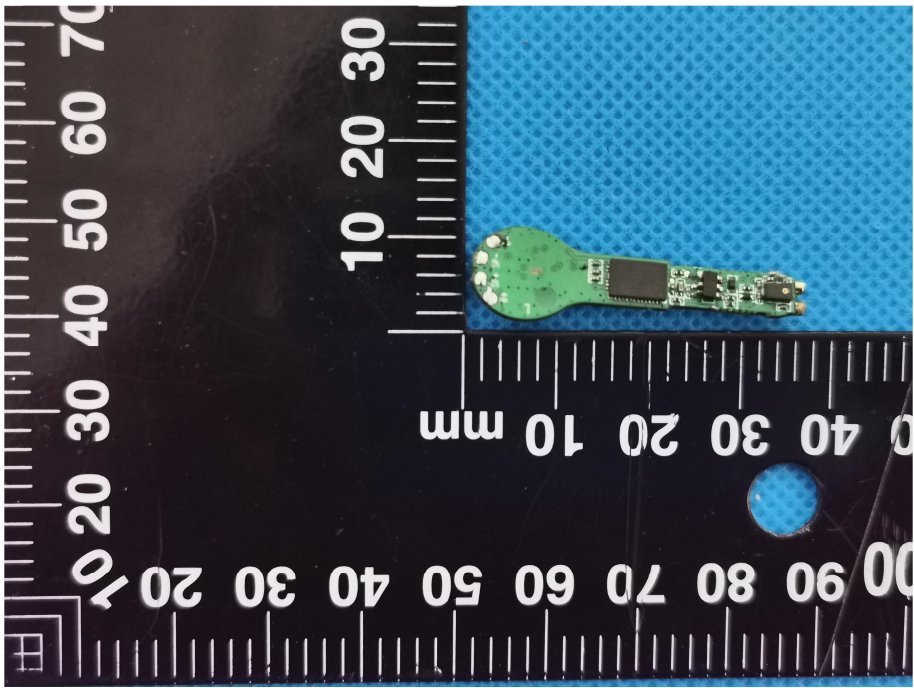
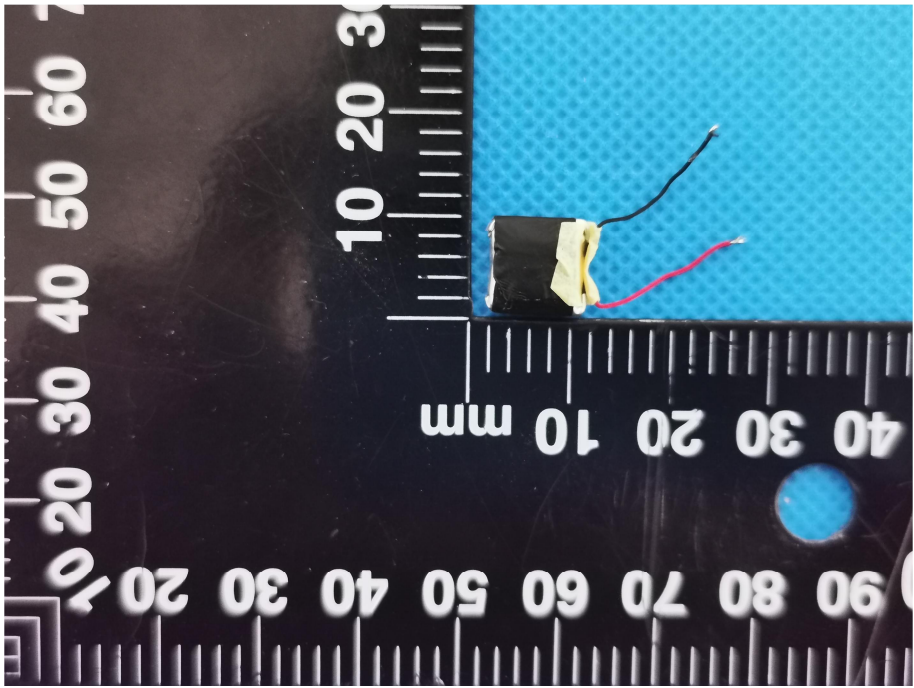
<p style="text-align: center;">Solder Board-Component View 2</p>	 A photograph showing a small electronic component, possibly a microcontroller or sensor, mounted on a blue perforated PCB. The component is positioned on a black surface with a white ruler for scale. The ruler shows markings from 0 to 100 mm. The component is oriented vertically, with its top edge near the 10 mm mark and its bottom edge near the 40 mm mark. The component has several pins and a small label that reads "R".
<p style="text-align: center;">Solder Board-Component View 3</p>	 A photograph showing a small electronic component, possibly a microcontroller or sensor, mounted on a blue perforated PCB. The component is positioned on a black surface with a white ruler for scale. The ruler shows markings from 0 to 100 mm. The component is oriented vertically, with its top edge near the 10 mm mark and its bottom edge near the 40 mm mark. The component has several pins and a small label that reads "R".

<p style="text-align: center;">Solder Board-Component View 4</p>	 A photograph showing a small, rectangular black component with a yellow solder mask and two thin wires (one red, one black) extending from it. The component is placed on a blue textured surface. A black ruler with white markings is visible in the background, showing measurements in millimeters. The ruler is oriented vertically, with the 0 mark at the top and the 100 mark at the bottom. The component is positioned between the 10 mm and 20 mm marks.
<p style="text-align: center;">Solder Board-Component View 5</p>	 A photograph showing a small, rectangular yellow component with two pins extending from one side. The component is placed on a blue textured surface. A black ruler with white markings is visible in the background, showing measurements in millimeters. The ruler is oriented vertically, with the 0 mark at the top and the 100 mark at the bottom. The component is positioned between the 10 mm and 20 mm marks.

<p style="text-align: center;">Solder Board-Component View 6</p>	 <p>A photograph showing a small yellow component with two pins, likely a capacitor, mounted on a blue textured surface. A black ruler with white markings is placed below the component for scale. The ruler shows millimeter markings from 0 to 100. The component is positioned between the 10 mm and 20 mm marks.</p>
<p style="text-align: center;">Antenna View</p>	 <p>A photograph showing a black antenna component with a circular base and a long, thin tail. A red box highlights the circular base, and a red line points to it from the text "BT Antenna" above. The component is placed on a blue textured surface next to a black ruler with white markings. The ruler shows millimeter markings from 0 to 100. The antenna is positioned between the 10 mm and 20 mm marks. The circular base has some markings, including "230IU".</p>

Left headset

<p>EUT Housing and Board View 1</p>	 A photograph showing the disassembled components of a left headset. From left to right: a black circular earpiece, a green printed circuit board (PCB) with various electronic components and a red LED, a black plastic housing with a microphone, and a black circular earpiece. The components are placed on a black ruler with white markings in millimeters. The ruler is oriented vertically on the left and horizontally at the bottom. The background is a blue textured surface.
<p>Solder Board-Component View 1</p>	 A close-up photograph of a small green PCB component. The component is rectangular and populated with several surface-mount components, including a microcontroller, resistors, and capacitors. It is placed on a black ruler with white markings in millimeters. The ruler is oriented vertically on the left and horizontally at the bottom. The background is a blue textured surface.

<p>Solder Board-Component View 2</p>	 A photograph showing a small green printed circuit board (PCB) component with several soldered connections. The component is placed on a blue textured surface. A black ruler with white markings is visible in the background, showing measurements in millimeters. The ruler is oriented vertically, with the 0 mark at the top and the 100 mark at the bottom. The component is positioned between the 10 mm and 30 mm marks on the ruler.
<p>Solder Board-Component View 3</p>	 A photograph showing a small black component with two wires (one red, one black) extending from it. The component is placed on a blue textured surface. A black ruler with white markings is visible in the background, showing measurements in millimeters. The ruler is oriented vertically, with the 0 mark at the top and the 100 mark at the bottom. The component is positioned between the 10 mm and 30 mm marks on the ruler.

